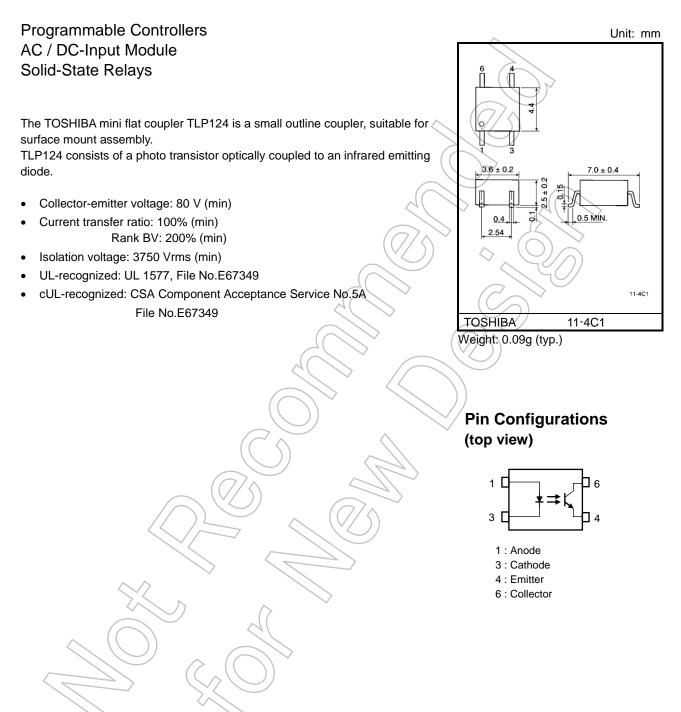
TLP124

TOSHIBA Photocoupler IRED & Photo-Transistor

TLP124



TOSHIBA

1

Current Transfer Ratio

	Cu			
Classification	Ta =	25°C	Ta = -25 to 75°C	Marking of
(Note 1)	I _F = 1 mA V _{CE} = 0.5 V	I _F = 0.5 mA V _{CE} = 1.5 V	I _F = 1 mA V _{CE} = 0.5 V	Classification
Rank BV	200%	100%	100%	BV
Standard	100%	50%	50%	BV, Blank

Note 1: Ex, rank BV: TLP124(BV)

Note: Application type name for certification test, please use standard product type name, i, e. TLP124(BV): TLP124

Absolute Maximum Ratings (Ta = 25°C)

	C (,		\geq	
	Characteristics	Symbol	Rating	Unit	
	Forward current	lF	50	mA	$\mathcal{A}(\mathbb{N})$
	Forward current derating (Ta ≥ 53°C)	ΔI _F /°C	-0.7	mA/°C	
ED	Peak forward current (100 µs pulse, 100 pps)	IFP		A	$\frac{2}{2}$
۳	Reverse voltage	VR	5	(\mathbf{x})	*
	Diode power dissipation	PD	100	mW	
	Diode power dissipation derating $(Ta \ge 53^{\circ}C)$	ΔPp/°C	-1.39	mW/°C	
	Junction temperature	Tj	125	°C	
	Collector-emitter voltage	VCEO	80	V	
	Emitter-collector voltage	VECO	7	V	
	Collector current	lc	50	mA	
Detector	Peak collector current (10 ms pulse, 100 pps)		100	mA	
å	Power dissipation	Pc	150	mW	
	Power dissipation derating (Ta ≥ 25°C)	ΔPc/°C	-1.5	mW/°C	
	Junction temperature		125	°C	
Stor	age temperature range	Tstg	-55 to 125	°C	
Оре	erating temperature range	Topr	-55 to 100	°C	
Lea	d soldering temperature (10 s)	T _{sol}	260	°C	
Tota	al package power dissipation	Рт	200	mW	
	al package power dissipation $(Ta \ge 25^{\circ}C)$	ΔP _T /°C	-2.0	mW/°C	
Isola (AC	ation voltage , 60 s, R.H. ≤ 60 %) (Note 1)	BVs	3750	Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Note 1: Device considered a two terminal device: Pins1, 3 shorted together and pins 4, 6 shorted together.

Recommended Operating Conditions

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	V _{CC}	_	5	48	V
Forward current	lF	_	1.6	20	mA
Collector current	lC	_	1	10	mA
Operating temperature	Topr	-25		75	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	VF	IF = 10 mA	1.0	1.15	1.3	V
LED	Reverse Current	IR	VR = 5 V	-(C		10	μΑ
	Capacitance	CT	V = 0 V, f = 1 MHz	K	30	_	pF
	Collector-emitter breakdown voltage	V _{(BR)CEO}	Ic = 0.5 mA	80	\rightarrow	-	V
or	Emitter-collector breakdown voltage	V _{(BR)ECO}	I _E = 0.1 mA	\mathcal{T}	—	-	V
Detector	Collector dark current	ICEO	Vce = 48 V		10	100	nA
ă			V _{CE} = 48 V, Ta = 85 °C)	2	50	μA
	Capacitance collector to emitter	CCE	V = 0 V, f = 1 MHz	_	12	_	pF

Coupled Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition		Min	Тур.	Max	Unit
Current transfer ratio	IC/IF	IF = 1 mA, VCE = 0.5 V		100	-	1200	%
			Rank BV	200	—	1200	70
		IF = 0.5 mA, VCE = 1.5 V		50	_	_	%
Low input CTR	IC/IF(low)		Rank BV	100	_	_	70
\searrow	$\langle -$	I _C = 0.5 mA, I _F = 1 mA		_	_	0.4	
Collector-emitter saturation voltage	VCE(sat)	NC = 1 mA, IF = 1 mA			0.2	_	V
2/	\wedge	\checkmark	Rank BV	_	_	0.4	
Off-state collector current	IC(off)	VF = 0.7 V, VCE = 48 V		_	_	10	μA

Coupled Electrical Characteristics (Ta = -25 to 75°C)

Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Current transfer ratio	IC/IF	I _F = 1 mA, V _{CE} = 0.5 V	50			%
	IC/IF	Rank BV	100			%
Low input CTR		I _F = 0.5 mA, V _{CE} = 1.5 V	_	50	_	%
	IC/IF(low)	Rank BV	_	100		%

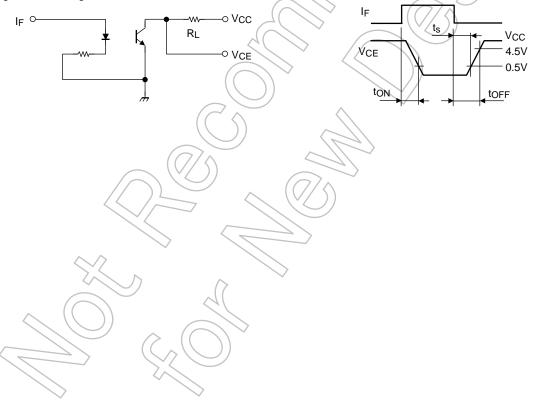
Isolation Characteristics (Ta = 25°C)

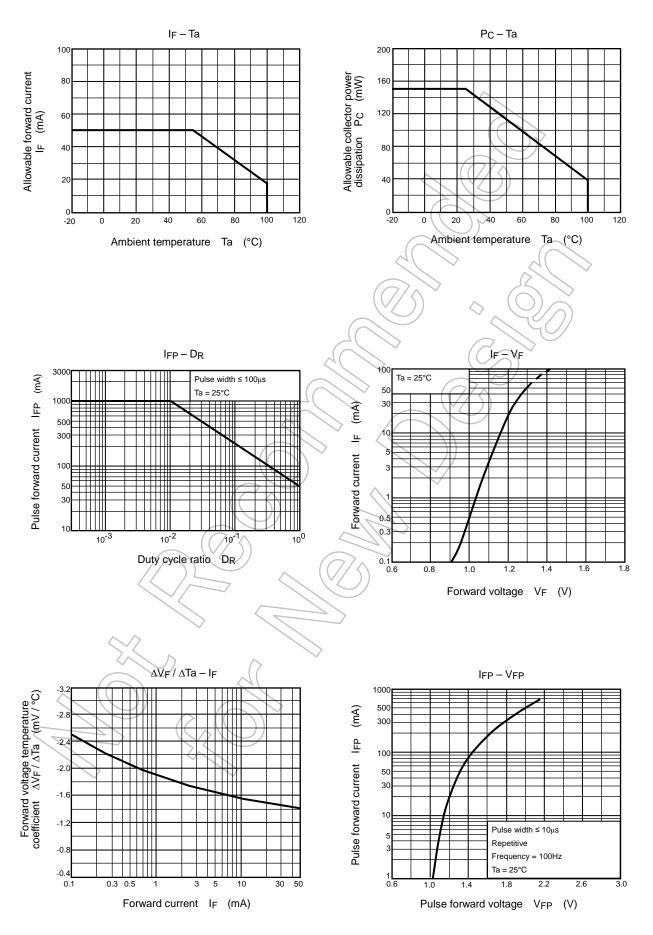
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance (input to output)	Cs	Vs = 0 V, f = 1 MHz	-	0.8	_	pF
Isolation resistance	R _S	V _S = 500 V, R.H. ≤ 60 %	5×10 ¹⁰	10 ¹⁴	_	Ω
Isolation voltage	BVs	AC, 60 s	3750	_	_	Vrms

Switching Characteristics (Ta = 25°C)

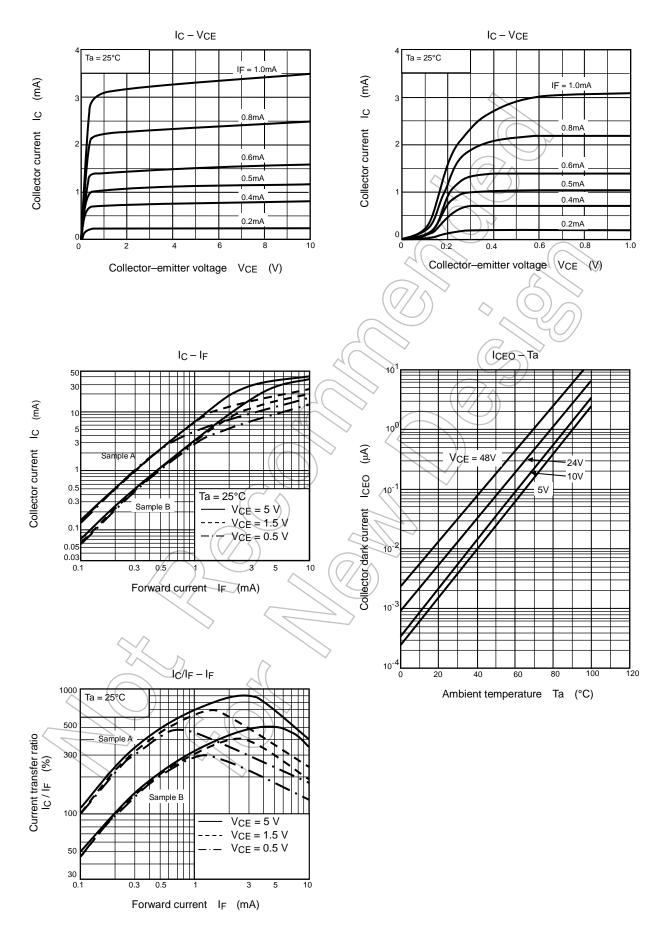
Characteristics	Symbol	Test Condition Min Typ. Max Un
Rise time	tr	
Fall time	tf	V _{CC} = 10 V, I _C = 2 mA - 8 -
Turn-on time	ton	R _L = 100 Ω – 10 – με
Turn-off time	tOFF	- 8 -
Turn-on time	ton	
Storage time	ts	$\begin{array}{c c} R_{L} = 4.7 k\Omega & (Fig.1) \\ V_{CC} = 5 (V, 1_{F} = 1.6 \text{ mA} & 50 & - \end{array} \\ \end{array} $
Turn-off time	tOFF	- 300 -

Fig. 1 Switching time test circuit

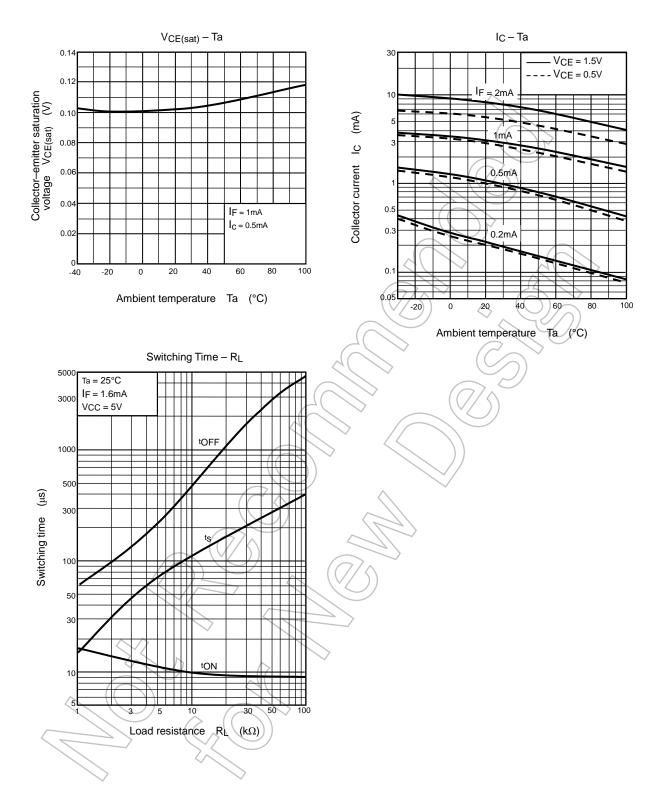




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